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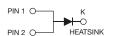
High Current Density Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.52$ V at $I_F = 3$ A



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SlimDPAK (TO-252AE)



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	6 A			
V _{RRM}	120 V			
I _{FSM}	100 A			
V _F at I _F = 6 A (T _J = 125 °C)	0.62 V			
T _J max.	150 °C			
Package	SlimDPAK (TO-252AE)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 1.3 mm
- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Automotive ordering code: base P/NHM3
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

MECHANICAL DATA

Case: SlimDPAK (TO-252AE)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

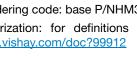
MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	V6PW12	UNIT	
Device marking code		V6PW12		
Maximum repetitive peak reverse voltage	V _{RRM}	120	V	
Maximum average forward rectified current (Fig. 1)	I _{F(AV)} ⁽¹⁾	6	А	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	100	А	
Operating junction temperature range	T _J ⁽²⁾	T _J ⁽²⁾ -40 to +150		
Storage temperature range	T _{STG}	-55 to +150	°C	

Notes

⁽¹⁾ With infinite heatsink

⁽²⁾ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{0,JA}$

- · Ideal for automated placement
- High efficiency operation
- AEC-Q101 qualified available



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V6PW12



RoHS COMPLIANT HALOGEN FREE

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V6PW12



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ELECTRICAL CHARACTERISTICS (T_J = 25 °C unless otherwise noted)							
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT	
Instantaneous forward voltage	I _F = 3 A	T _J = 25 °C	V _E ⁽¹⁾	0.59	-	V	
	I _F = 6 A			0.77	0.82		
	I _F = 3 A	T _J = 125 °C		VF \	0.52	-	v
	I _F = 6 A			0.62	0.67		
Reverse current	V 00.V	T _J = 25 °C	I _R (2)	0.002	-	mA	
	V _R = 90 V	T _J = 125 °C		2	-		
	V _B = 120 V	T _J = 25 °C		-	0.4		
	v _R = 120 v	T _J = 125 °C		4	12		
Typical junction capacitance	4.0 V, 1 MHz		CJ	510	-	pF	

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: pulse width \leq 5 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER SYM		V6PW12	UNIT	
Typical thermal resistance	R _{0JA} ⁽¹⁾⁽²⁾	65	°C/W	
	R _{0JM} ⁽³⁾	3.0	0/10	

Notes

 $^{(1)}$ The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

 $^{(2)}\,$ Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

 $^{(3)}$ Mounted on infinite heat sink; thermal resistance $R_{\theta JM}$ - junction-to-mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V6PW12-M3/I	0.20	I	4500	13" diameter plastic tape and reel	
V6PW12HM3/I ⁽¹⁾	0.20	I	4500	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

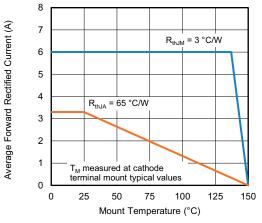


Fig. 1 - Maximum Forward Current Derating Curve

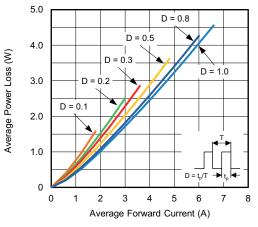


Fig. 2 - Forward Power Loss Characteristics

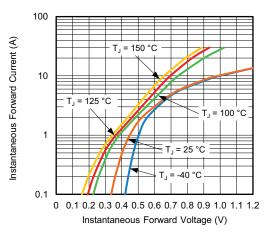


Fig. 3 - Typical Instantaneous Forward Characteristics

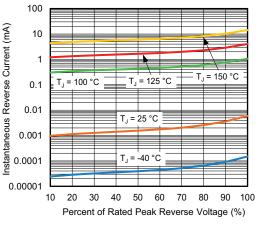


Fig. 4 - Typical Reverse Leakage Characteristics

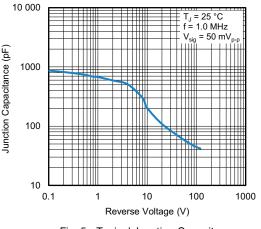


Fig. 5 - Typical Junction Capacitance

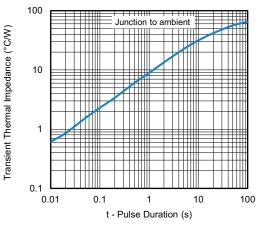


Fig. 6 - Typical Transient Thermal Impedance

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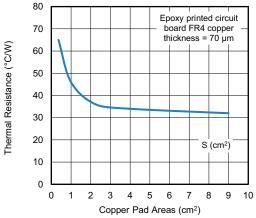
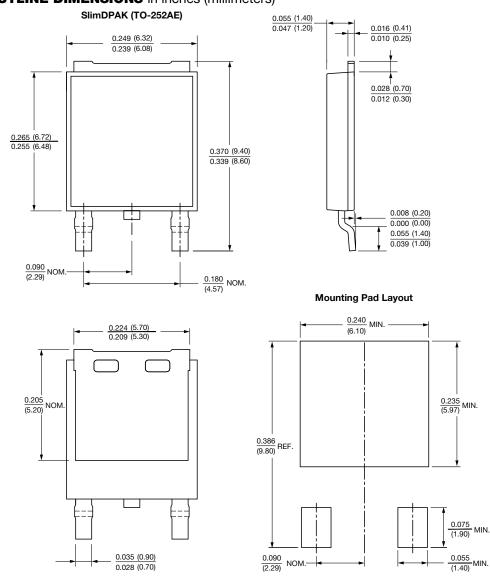


Fig. 7 - Typical Resistance Junction to Ambient vs. Copper Pad Areas





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